



(43) International Publication Date
22 September 2016 (22.09.2016)

(51) International Patent Classification:
B41J 2/14 (2006.01)

(21) International Application Number:
PCT/JP2016/001389

(22) International Filing Date:
11 March 2016 (11.03.2016)

(25) Filing Language: English

(26) Publication Language: English

(30) Priority Data:
2015-052890 17 March 2015 (17.03.2015) JP

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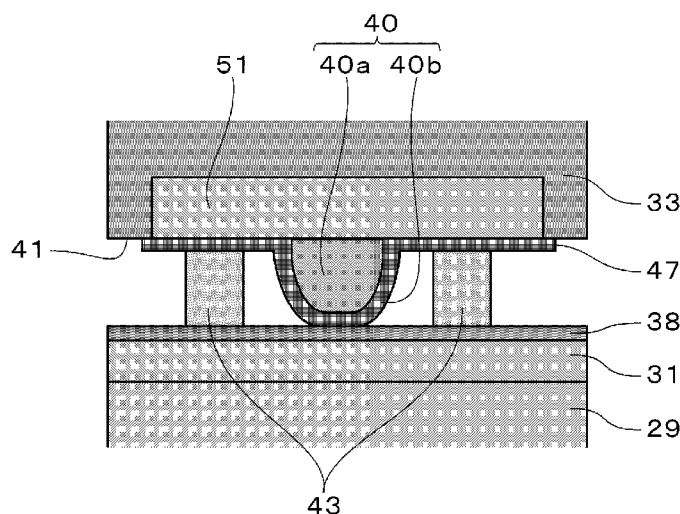
(81) Designated States (unless otherwise indicated, for every kind of national protection available): AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BN, BR, BW, BY, BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IR, IS, KE, KG, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PA, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW, SA, SC, SD, SE, SG, SK, SL, SM, ST, SV, SY, TH, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.

(84) Designated States (unless otherwise indicated, for every kind of regional protection available): ARIPO (BW, GH, GM, KE, LR, LS, MW, MZ, NA, RW, SD, SL, ST, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, RU, TJ, TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK, SM, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, KM, ML, MR, NE, SN, TD, TG).

Published:

— with international search report (Art. 21(3))

(54) Title: LIQUID JET HEAD AND METHOD FOR MANUFACTURING LIQUID JET HEAD



(57) Abstract: Provided are a liquid jet head with which the size-reduction can be achieved, while the resistance of wiring formed on a wiring plate such as a sealing plate is lowered, and a method for manufacturing the liquid jet head. The liquid jet head includes: a sealing plate 33 having a first surface 41 to which a pressure chamber-forming plate 29 including multiple piezoelectric elements 32 is joined and a second surface 42 which is on a side opposite from the first surface 41 and to which a drive IC 34 that outputs signals for driving the piezoelectric elements 32 is joined, wherein a lower surface-side embedded wire 51 connected to a common wire 38 common to the driving elements 32 are formed on the first surface 41 of the sealing plate 33, and the lower surface-side embedded wire 51 is at least partially embedded in the sealing plate 33.

